

EAST - (10036389.wsp.1)

File View Edit Tools Window Help

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USPAT; EPO; JPO; DERWENT; IBM; TDB

Default operator: OR ☐ Plurals ☒ Highlight all hit terms initially

1 with (heat or heat adj sink or heat adj spreader)

☒ OR ☒ AND ☐ Image ☐ Text ☐ HTML

	U	I	Document ID	Issue Date	Pages	Title	Current OR	Current XRef
1	<input type="checkbox"/>	<input type="checkbox"/>	US 6672947 B2	20040106	14	Method for global die thinning and polishing of flip-chip packaged integrated circuits	451/57	438/108; 438/113;
2	<input type="checkbox"/>	<input type="checkbox"/>	US 6672154 B1	20040106	29	Flow rate sensor unit, flowmeter and flow sensor	73/204.22	
3	<input type="checkbox"/>	<input type="checkbox"/>	US 6666947 B2	20031223	9	Method for producing an inkjet printhead element; and an inkjet printhead element	156/326	156/324.4; 156/330;
4	<input type="checkbox"/>	<input type="checkbox"/>	US 6661083 B2	20031209	15	Plastic semiconductor package	257/676	257/666
5	<input type="checkbox"/>	<input type="checkbox"/>	US 6617683 B2	20030909	9	Thermal performance in flip chip/integral heat spreader packages using low modulus	257/707	257/713; 257/720;
6	<input type="checkbox"/>	<input type="checkbox"/>	US 6590278 B1	20030708	9	Electronic package	257/675	257/706
7	<input type="checkbox"/>	<input type="checkbox"/>	US 6589818 B2	20030708	13	Method for mounting a thin semiconductor device	438/118	438/458; 438/459;
8	<input type="checkbox"/>	<input type="checkbox"/>	US 6572978 B1	20030603	5	Method of making wood composition boards resistant to water permeation	428/513	427/387; 427/393;
9	<input type="checkbox"/>	<input type="checkbox"/>	US 6532720 B2	20030318	10	Packaging method using elastic memory foam as safety indicator for heat damage	53/472	206/459.1; 53/474
10	<input type="checkbox"/>	<input type="checkbox"/>	US 6514796 B2	20030204	13	Method for mounting a thin semiconductor device	438/118	438/119; 438/458;
11	<input type="checkbox"/>	<input type="checkbox"/>	US 6500699 B1	20021231	10	Test fixture for future integration	438/121	385/14